# Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date		
Akihiro Hosokawa	10/03/2005		
Makoto Inagawa	09/27/2005		
Hienminh Huu Le	09/27/2005		
John M White	09/22/2005		

#### **RECEIVING PARTY DATA**

Name:	Applied Materials, Inc.		
Street Address:	050 Bowers Avenue		
City:	Santa Clara		
State/Country:	CALIFORNIA		
Postal Code:	95054		

## PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11213662

#### **CORRESPONDENCE DATA**

Fax Number: (408)986-3090

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 408-563-2492

Email: maureen\_walstra@amat.com

Correspondent Name: Applied Materials, Inc. Address Line 1: P. O. Box 450 A

Address Line 4: Santa Clara, CALIFORNIA 95052

NAME OF SUBMITTER: Maureen Walstra

Total Attachments: 2

500179216

source=10169 US exec Assign#page1.tif

PATENT REEL: 018518 FRAME: 0773 . \$40.00

source=10169 US exec Assign#page2.tif

PATENT REEL: 018518 FRAME: 0774

## **ASSIGNMENT FOR APPLICATION FOR PATENT**

WHEREAS:

Names and Addresses of Inventors:

1)	AKIHIRO HOSOKAWA 10264 Danube Dr. Cupertino, CA 95014	2)	MAKOTO INAGAWA 738 Matadero Ave. Palo Alto, California 94306
3)	HIENMINH HUU LE 2656 Flint Ave. San Jose, CA 95148	4)	JOHN M. WHITE 2811 Colony View Place Hayward, CA 94541

(hereinafter referred to as Assignors), have invented a certain invention entitled:

## INTEGRATED PVD SYSTEM USING DESIGNATED PVD CHAMBERS

enclosed herewith or for which application for Letters Patent in the United States was filed on August 26, 2005, under Serial No. 11/213,662, executed on even date herewith; and

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, California 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a conventional, division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.

010169 ASSIGNMENT.DOC

PATENT

- 2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting conventional, substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefor and any Patents granted including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.
- 3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.
- 4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF	, the	said	Assignors	have	executed	and	delivered
this instrument to said Assignee o	on the	e date	es indicated	d belo	w. /	1	

1)	10/3/05- (DATE)
٠,	(5/(12)

AKIHIRÓ HOSOKAWA

2) <u>927(05</u> (DATE)

MAKOTO INAGAWA

3) <u>427/05</u> (DATE)

HIENMINH HUU LE

4) <u>9/22/05</u> (DATE

JOHN M. WHITE